

Middle Power LED Series
3030

LM301H
CRI 80

For Horticulture Lighting



Features & Benefits

- Middle power LED
- Mold resin for high reliability
- Standard form factor for design flexibility (3.0 × 3.0 mm)



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1. Characteristics

a) Absolute Maximum Rating

Item	Symbol	Rating	Unit	Condition
Ambient / Operating Temperature	T_a	-40 ~ +85	°C	-
Storage Temperature	T_{stg}	-40 ~ +120	°C	-
LED Junction Temperature	T_j	110	°C	-
Forward Current	I_F	200	mA	-
Pulse Forward Current	I_{FP}	300	mA	Duty 1/10, pulse width 10ms
Assembly Process Temperature	-	260 <10	°C s	-
ESD (HBM)	-	5	kV	-

b) Electro-optical Characteristics ($I_F = 65 \text{ mA}$, $T_s = 25^\circ\text{C}$)

Item	Unit	Rank	Bin	Min.	Typ.	Max.
Forward Voltage (V_F)	V	XA	AY	2.6	-	2.7
			AZ	2.7	-	2.8
			A1	2.8	-	2.9
Reverse Voltage (@ 5 mA)	V			0.7	-	1.2
Color Rendering Index (R_a)	-			80	-	-
Thermal Resistance (junction to solder point)	°C/W			-	7.5	-
Beam Angle	°			-	120	-

Note:

Samsung maintains measurement tolerance of: forward voltage = $\pm 0.1 \text{ V}$, luminous flux = $\pm 5 \%$, CRI = ± 3

c) Electro-optical Characteristics ($I_F = 65 \text{ mA}$, $T_s = 25^\circ\text{C}$)

Item	CRI	Nominal CCT (K)	SF		SG		SH		SJ		SK		SL		SM	
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.		
			28	30	30	32	32	34	34	36	36	38	38	40	40	42
Luminous Flux (Φ_v)	80	2200														
		2700														
		3000														
		3500														
		4000														
		5000														
		5700														
		6500														

CRI	Nominal CCT (K)	PPF ($\mu\text{mol/s}$) @65mA	PPE ($\mu\text{mol/J}$)
80	2700	0.500	2.83
80	3000	0.511	2.89
80	3500	0.517	2.92
80	4000	0.528	2.98
80	5000	0.544	3.08
80	5700	0.542	3.07
80	6500	0.541	3.06

Note:

Samsung maintains measurement tolerance of: forward voltage = $\pm 0.1\text{V}$, luminous flux = $\pm 5\%$, CRI = ± 3

PPF, PPE : Calculated, Reference only

2. Product Code Information

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
S	P	M	W	H	D	3	2	A	M	H	5	X	A	R	0	S	0

Digit	PKG Information	Code	Specification						
1 2 3	Samsung Package Middle Power	SPM							
4 5	Color	WH	White						
6	Product Version	D	Dispensing						
7 8 9	Form Factor	32A	3.0 x 3.0 x 0.7 mm; 2 pads;						
10	Sorting Current (mA)	M	65 mA						
11	Chromaticity Coordinates	H	Horticulture						
12	CRI	5	Min. 80						
13 14	Forward Voltage (V)	XA	<table> <tr> <td>AY</td><td>2.6~2.7</td></tr> <tr> <td>Bin Code: AZ</td><td>2.7~2.8</td></tr> <tr> <td>A1</td><td>2.8~2.9</td></tr> </table>	AY	2.6~2.7	Bin Code: AZ	2.7~2.8	A1	2.8~2.9
AY	2.6~2.7								
Bin Code: AZ	2.7~2.8								
A1	2.8~2.9								
15 16	CCT (K)	Y●	2200 YE, YF, YG, YH, YI, YK, YL, YM						
		W●	2700 WE, WF, WG, WH, WJ, WK, WM						
		V●	3000 VE, VF, VG, VH, VJ, VK, VL, VM						
		U●	3500 UE, UF, UG, UH, UJ, UK, UL, UM						
		T●	4000 TE, TF, TG, TH, TJ, TK, TL, TM						
		R●	5000 RE, RF, RG, RH, RJ, RK, RL, RM						
		Q●	5700 QE, QF, QG, QH, QJ, QK, QL, QM						
17 18	Luminous Flux	S0	SF, SG, SH, SJ, SK, SL, SM						
		L2	SL+SM / SM+SM						
		SG	SG 30.0 ~ 32.0						
		SJ	Bin Code: SJ 34.0 ~ 36.0						
		SK	SK 36.0 ~ 38.0						
		SL	SL 38.0 ~ 40.0						

● : "0" (Whole bin) or "5" (MacAdam 5-step ellipse bin)

a) Luminous Flux Bins($I_F = 65 \text{ mA}$, $T_s = 25^\circ\text{C}$)

CRI (R _a) Min.	Nominal CCT (K)	Product Code	Flux Bin	Flux Range (Φ _v , lm)	
80	2200	SPMWHD32AMH5XAY●S0	SF	28.0~30.0	
			SG	30.0~32.0	
			SH	32.0~34.0	
		SPMWHD32AMH5XAY●SG	SG	30.0~32.0	
			SH	32.0~34.0	
			2700	SPMWHD32AMH5XAW●S0	SJ
	SK	36.0~38.0			
	SPMWHD32AMH5XAW●SJ	SJ			34.0~36.0
	3000	SPMWHD32AMH5XAV●S0	SJ	34.0~36.0	
			SK	36.0~38.0	
			SL	38.0~40.0	
		SPMWHD32AMH5XAV●SK	SK	36.0~38.0	
			SJ	34.0~36.0	
			3500	SPMWHD32AMH5XAU●S0	SK
	SL	38.0~40.0			
	SPMWHD32AMH5XAU●SL	SL			38.0~40.0
	4000	SPMWHD32AMH5XAT●S0		SK	36.0~38.0
				SL	38.0~40.0
				SPMWHD32AMH5XAT●SL	SL
		5000	SPMWHD32AMH5XAR●S0	SK	36.0~38.0
				SL	38.0~40.0
				SM	40.0~42.0
	SPMWHD32AMH5XAR●SL		SL	38.0~40.0	
			SPMWHD32AMH5XAR●L2	SL	38.0~40.0
SM			40.0~42.0		
5700	SPMWHD32AMH5XAQ●S0	SK	36.0~38.0		
		SL	38.0~40.0		
		SPMWHD32AMH5XAQ●SL	SL	38.0~40.0	
	6500	SPMWHD32AMH5XAP●S0	SK	36.0~38.0	
			SL	38.0~40.0	
			SPMWHD32AMH5XAP●SL	SL	38.0~40.0

Note:

- : "0" (Whole bin) or "5" (MacAdam 5-step ellipse bin)

b) Kitting Rule (for L2 Rank)

1. Under agreement between customer and SAMSUNG, SAMSUNG can supply kitting bin (1m).
2. A luminous flux of kitting bin is combined by a pair of IV rank such as (SL+SM) or (SM+SM).

[Binning Information]

	Bin #1	Bin #2	Remark
IV	SL	SM	L2
	SM	SM	

c) Color Bins ($I_f = 65 \text{ mA}$, $T_s = 25^\circ\text{C}$)

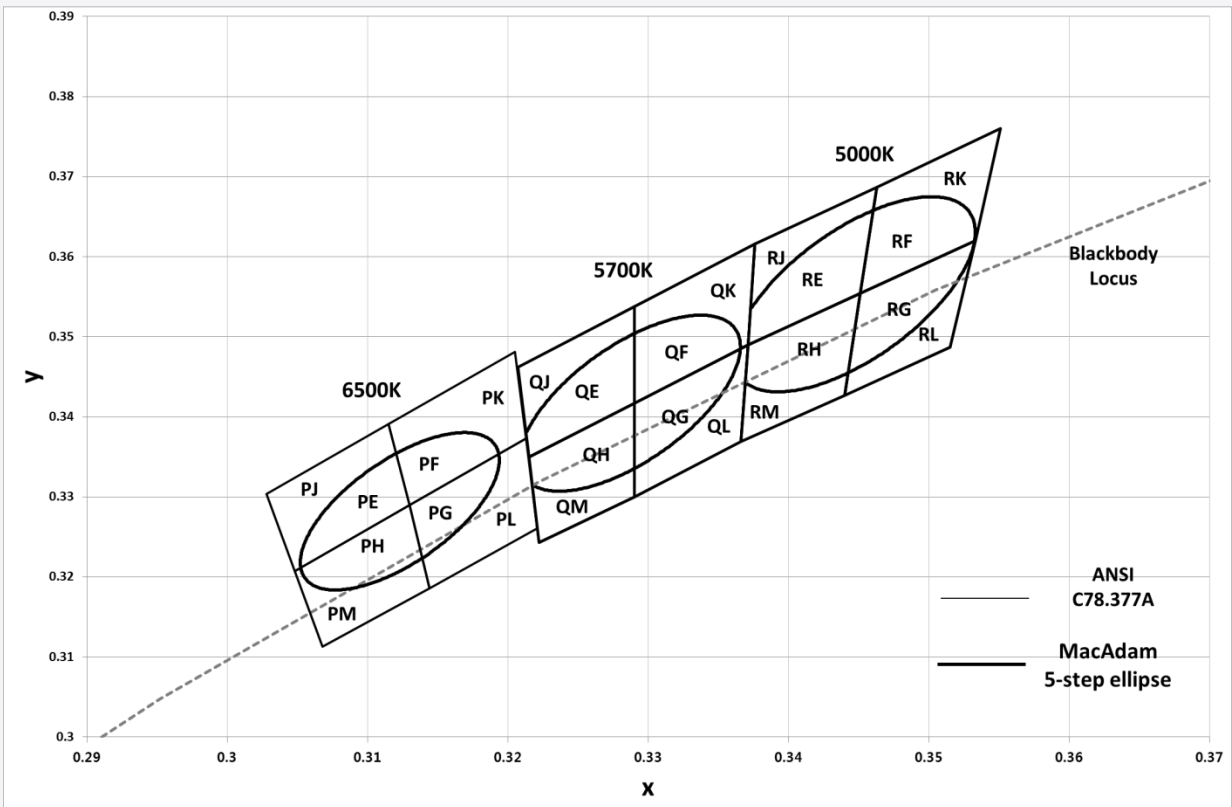
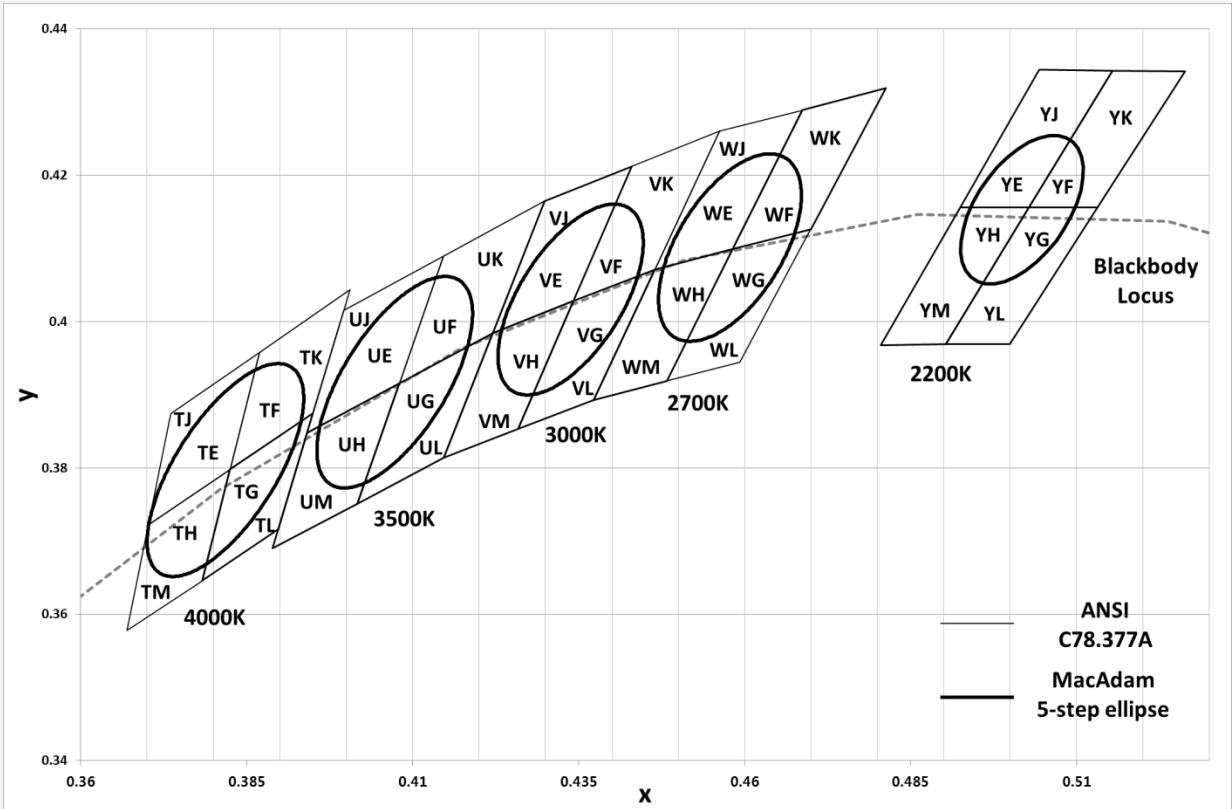
min. CRI	Nominal CCT	Product Code	Color Rank	Chromaticity Bins	
80	2200	SPMWHD32AMH5XAY0S★	Y0	Whole bin	YE, YF, YG, YH, YJ, YK, YL, YM
		SPMWHD32AMH5XAY5S★	Y5	MacAdam 5-step ellipse bin	YE, YF, YG, YH
	2700	SPMWHD32AMH5XAW0S★	W0	Whole bin	WE, WF, WG, WH, WJ, WK, WL, WM
		SPMWHD32AMH5XAW5S★	W5	MacAdam 5-step ellipse bin	WE, WF, WG, WH
	3000	SPMWHD32AMH5XAV0S★	V0	Whole bin	VE, VF, VG, VH, VJ, VK, VL, VM
		SPMWHD32AMH5XAV5S★	V5	MacAdam 5-step ellipse bin	VE, VF, VG, VH
	3500	SPMWHD32AMH5XAU0S★	U0	Whole bin	UE, UF, UG, UH, UJ, UK, UL, UM
		SPMWHD32AMH5XAU5S★	U5	MacAdam 5-step ellipse bin	UE, UF, UG, UH
	4000	SPMWHD32AMH5XAT0S★	T0	Whole bin	TE, TF, TG, TH, TJ, TK, TL, TM
		SPMWHD32AMH5XAT5S★	T5	MacAdam 5-step ellipse bin	TE, TF, TG, TH
	5000	SPMWHD32AMH5XAR0S★	R0	Whole bin	RE, RF, RG, RH, RJ,RK,RL,RM
		SPMWHD32AMH5XAR0L2			
		SPMWHD32AMH5XAR5S★	R5	MacAdam 5-step ellipse bin	RE, RF, RG, RH
	5700	SPMWHD32AMH5XAQ0S★	Q0	Whole bin	QE, QF, QG, QH, QJ, QK, QL, QM
		SPMWHD32AMH5XAQ5S★	Q5	MacAdam 5-step ellipse bin	QE, QF, QG, QH
	6500	SPMWHD32AMH5XAP0S★	P0	Whole bin	PE, PF, PG, PH, PJ, PK, PL, PM
SPMWHD32AMH5XAP5S★		P5	MacAdam 5-step ellipse bin	PE, PF, PG, PH	

★ can be "0", "G", "J", "K", "L" of the luminous flux

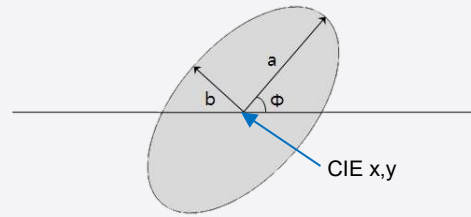
d) Voltage Bins ($I_f = 65 \text{ mA}$, $T_s = 25^\circ\text{C}$)

CRI (Ra) Min.	Nominal CCT (K)	Product Code	Voltage Rank	Voltage Bin	Voltage Range (V)
-	-	-	-	AY	2.6 ~ 2.7
-	-	-	XA	AZ	2.7 ~ 2.8
-	-	-	-	A1	2.8 ~ 2.9

e) Chromaticity Region & Coordinates ($I_f = 65 \text{ mA}$, $T_s = 25^\circ\text{C}$)



f) Chromaticity Region & Coordinates ($I_f = 65 \text{ mA}$, $T_s = 25^\circ\text{C}$)



MacAdam Ellipse (Y5)					
Step	CIE x	CIE y	Step	CIE x	CIE y
5-step	0.5018	0.4153	-39.89	0.00667	0.01201

MacAdam Ellipse (W5)					
Step	CIE x	CIE y	Step	CIE x	CIE y
5-step	0.4578	0.4101	53.70	0.01350	0.00700

MacAdam Ellipse (V5)					
Step	CIE x	CIE y	θ	a	b
5-step	0.4338	0.4030	53.22	0.01390	0.00680

MacAdam Ellipse (U5)					
Step	CIE x	CIE y	θ	a	b
5-step	0.4073	0.3917	54.00	0.01545	0.00690

MacAdam Ellipse (T5)					
Step	CIE x	CIE y	θ	a	b
5-step	0.3818	0.3797	53.72	0.01565	0.00670

MacAdam Ellipse (R5)					
Step	CIE x	CIE y	θ	a	b
5-step	0.3447	0.3553	59.62	0.01370	0.00590

MacAdam Ellipse (Q5)					
Step	CIE x	CIE y	θ	a	b
5-step	0.3287	0.3417	59.09	0.01243	0.00533

MacAdam Ellipse (P5)					
Step	CIE x	CIE y	θ	a	b
5-step	0.3123	0.3282	58.57	0.01115	0.00475

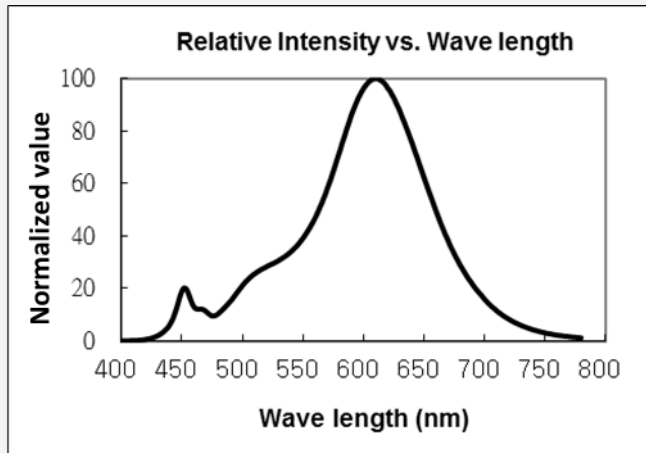
Note:

Samsung maintains measurement tolerance of: $C_x, C_y = \pm 0.005$

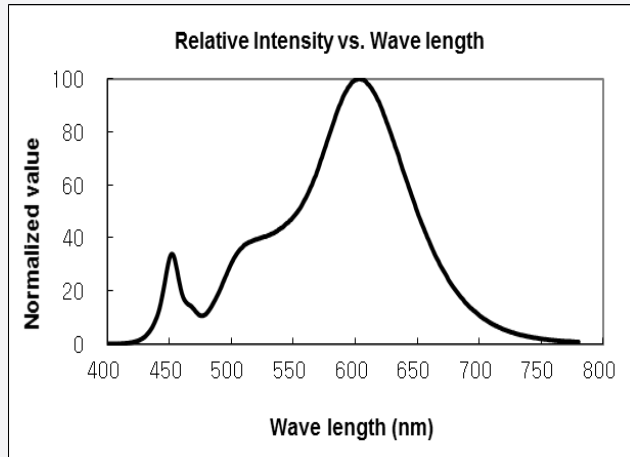
3. Typical Characteristics Graphs

a) Spectrum Distribution (I_f = 65 mA, T_s = 25°C)

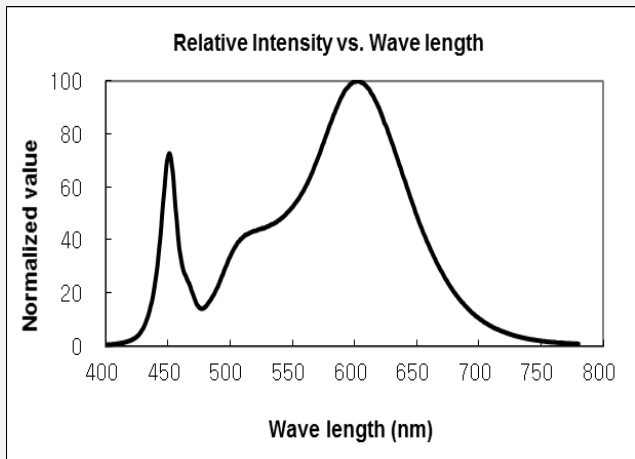
CCT : 2200K (80 CRI)



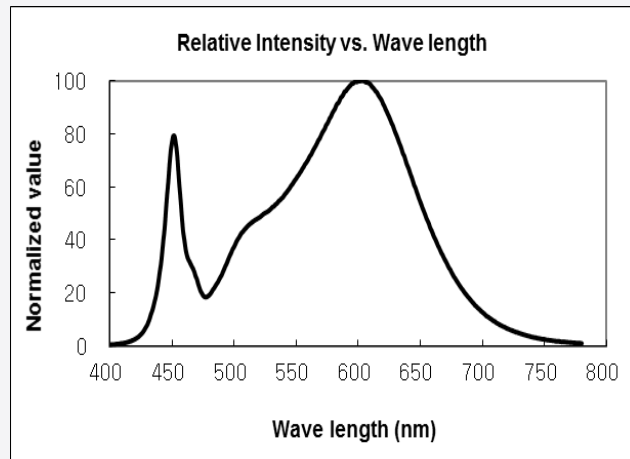
CCT : 2700K (80 CRI)



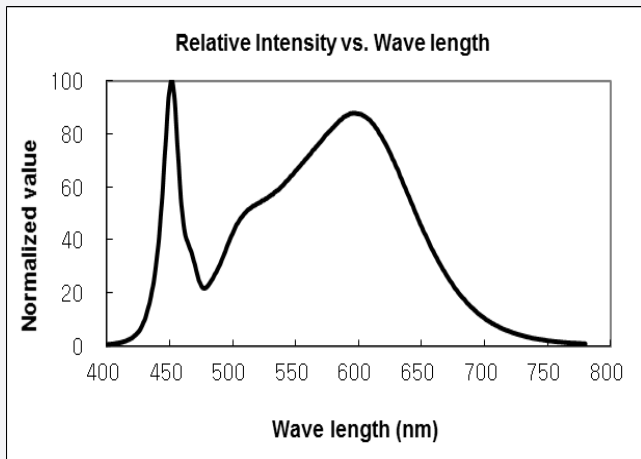
CCT : 3000K (80 CRI)



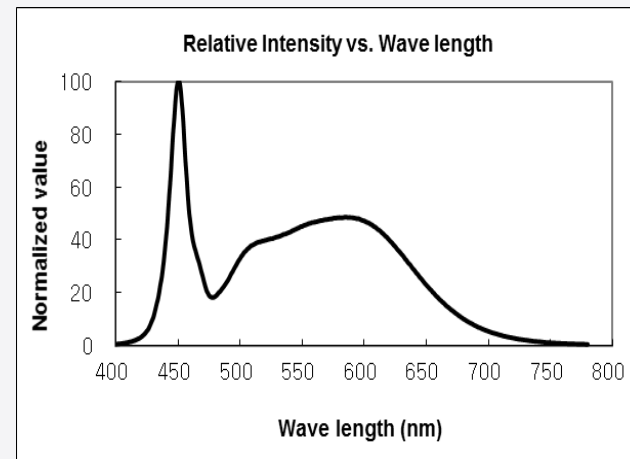
CCT : 3500K (80 CRI)



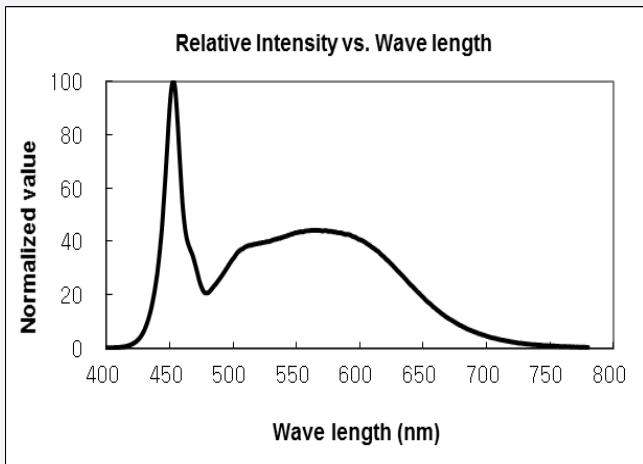
CCT : 4000K (80 CRI)



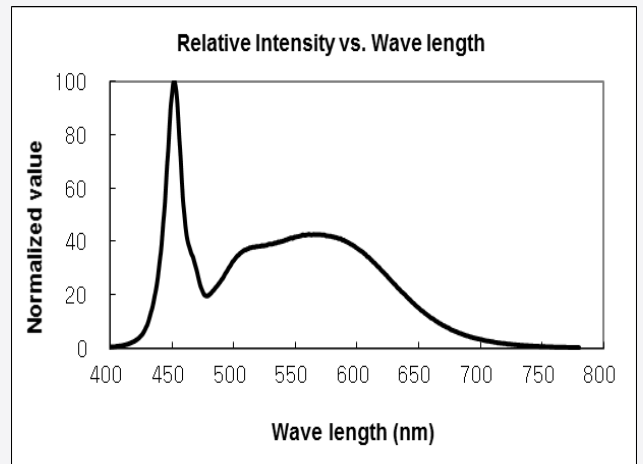
CCT : 5000K (80 CRI)



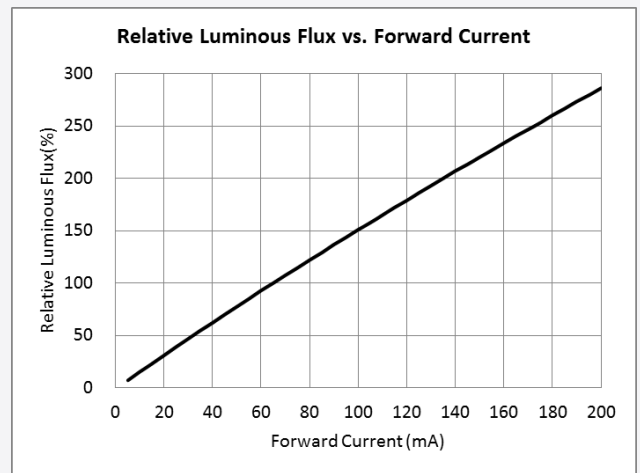
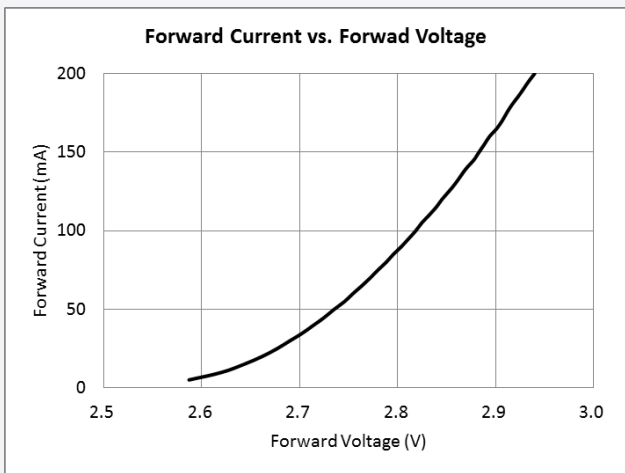
CCT : 5700K (80 CRI)



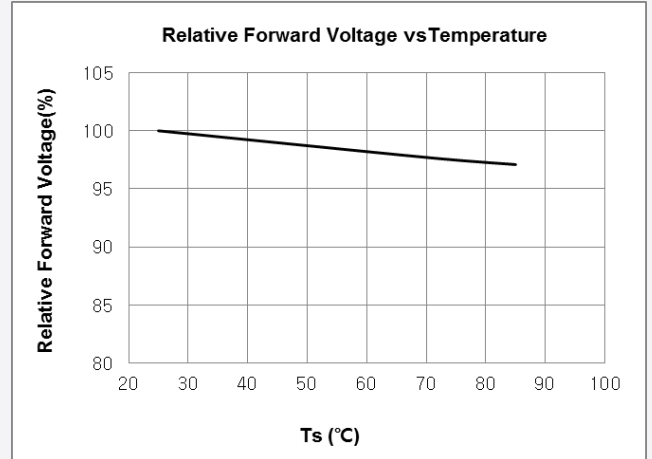
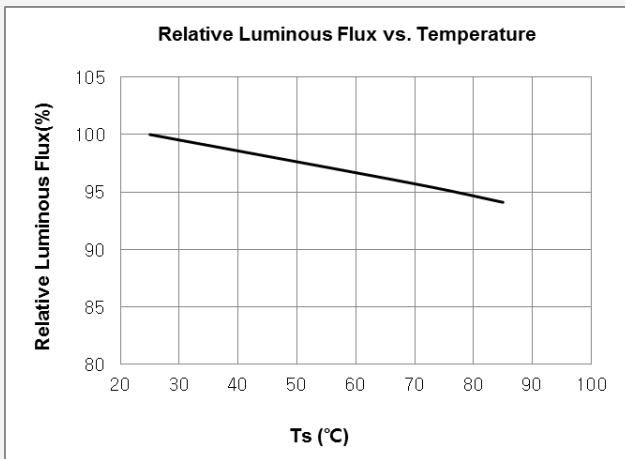
CCT : 6500K (80 CRI)



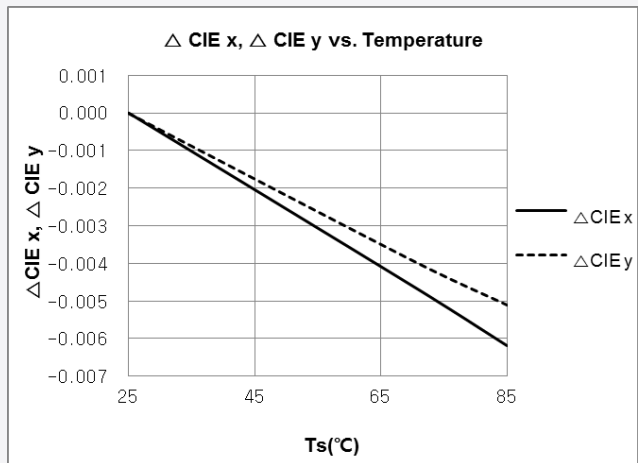
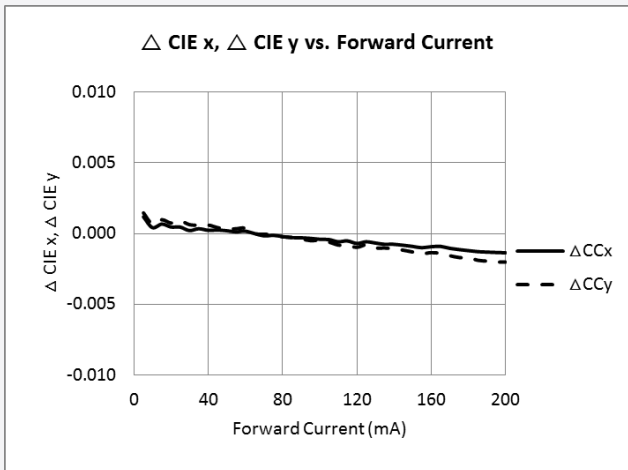
b) Forward Current Characteristics ($T_s = 25^\circ\text{C}$)



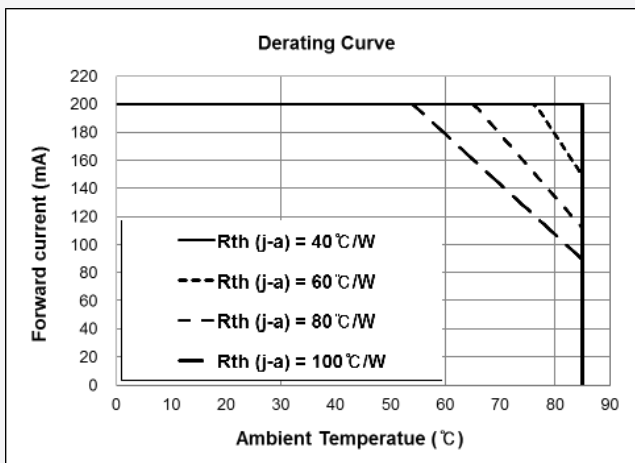
c) Temperature Characteristics ($I_f = 65 \text{ mA}$)



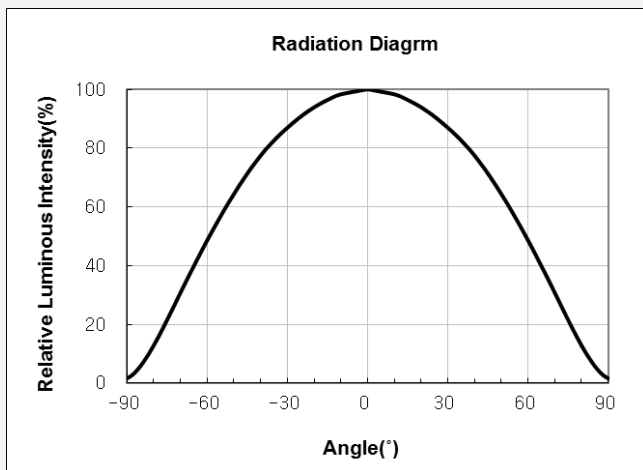
d) Color Shift Characteristics, $T_s = 25^\circ\text{C}$, $I_f = 65\text{ mA}$



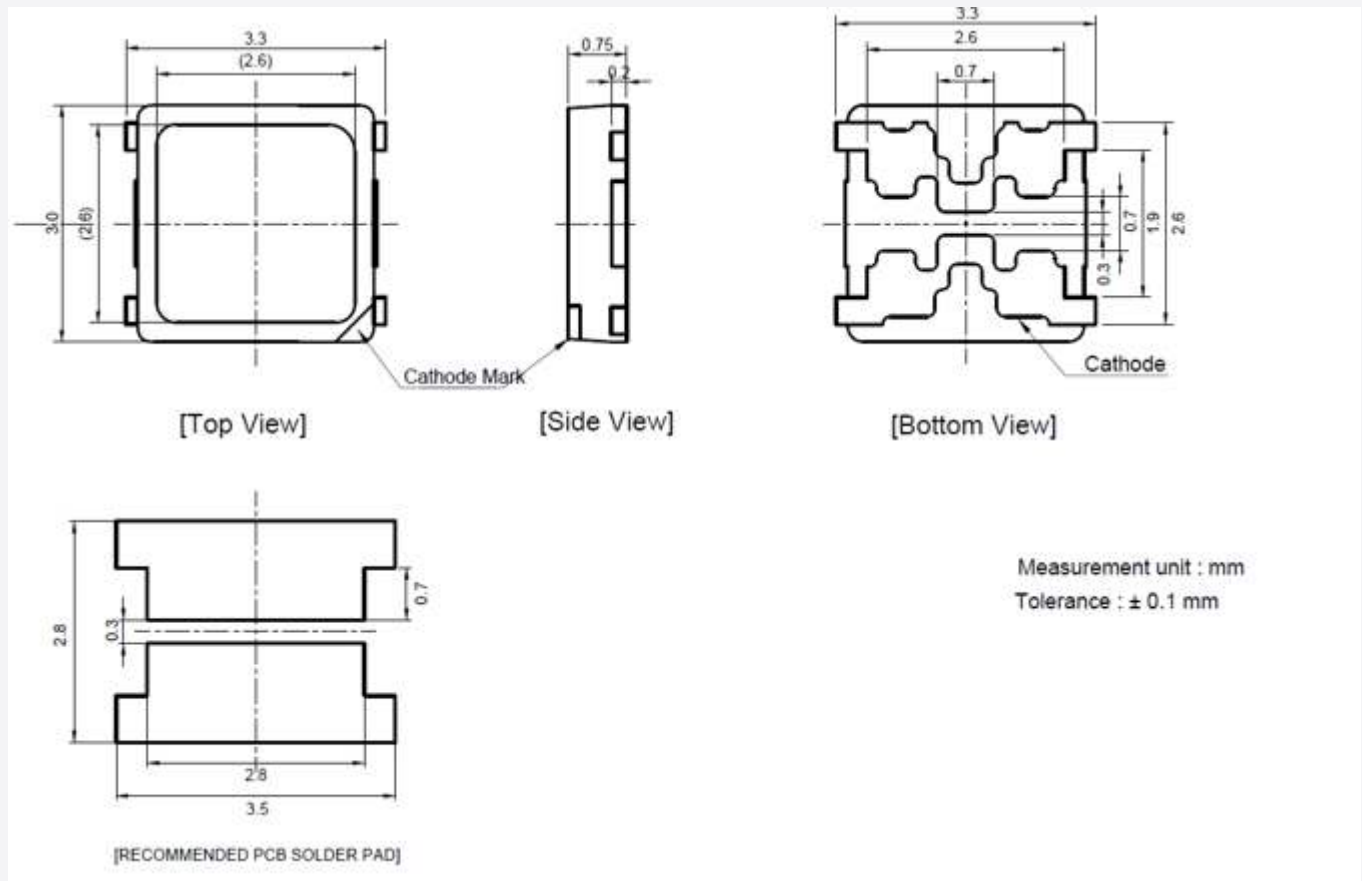
e) Derating Curve



f) Beam Angle Characteristics ($T_s = 25^\circ\text{C}$, $I_f = 65\text{ mA}$)



4. Outline Drawing & Dimension



Notes:

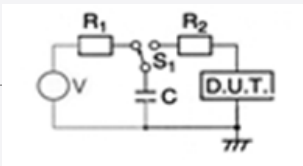
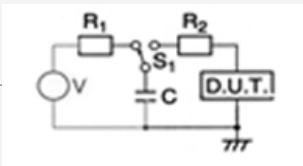
- 1) This LED has built-in ESD protection device(s) connected in parallel to LED chip(s).
- 2) T_s point and measurement method:
 - ① Measure one point at the cathode pad, if necessary remove PSR of PCB to reach T_s point.
 - ② All pads must be soldered to the PCB to dissipate heat properly, otherwise the LED can be damaged.

Precautions:

- 1) Pressure on the LEDs will influence to the reliability of the LEDs. Precautions should be taken to avoid strong pressure on the LEDs. Do not put stress on the LEDs during heating.
- 2) Re-soldering should not be done after the LEDs have been soldered. If re-soldering is unavoidable, LED's characteristics should be carefully checked before and after such repair.
- 3) Do not stack assembled PCBs together. Since materials of LEDs is soft, abrasion between two PCB assembled with LED might cause catastrophic failure of the LEDs.

5. Reliability Test Items & Conditions

a) Test Items

Test Item	Test Condition	Test Hour / Cycle	Sample No.
Room Temperature Life Test	25°C, DC 200 mA	1000 h	22
High Temperature Life Test	85°C, DC 200 mA	1000 h	22
High Temperature Humidity Life Test	85°C, 85 % RH, DC 200 mA	1000 h	22
Low Temperature Life Test	-40°C, DC 200 mA	1000 h	22
Powered Temperature Cycle Test	-40 °C ~ 85°C, each 10 min, On/Off 5min , Temp. Change Time 20min, DC 200 mA	100 cycles	22
Thermal Cycle	-45°C / 15 min ↔ 125°C / 15 min → Hot plate 180°C	500 cycles	100
High Temperature Storage	120°C	1000 h	11
Low Temperature Storage	-40°C	1000 h	11
ESD (HBM)	 <p> R_1: 10 MΩ R_2: 1.5 kΩ C: 100 pF V: ± 5 kV </p>	5 times	30
ESD (MM)	 <p> R_1: 10 MΩ R_2: 0 C: 200 pF V: ± 0.5 kV </p>	5 times	30
Vibration Test	20~2000~20 Hz, 200 m/s ² , sweep 4 min X, Y, Z 3 direction, each 1 cycle	4 cycles	11
Mechanical Shock Test	1500 g, 0.5 ms 3 shocks each X-Y-Z axis	5 cycles	11

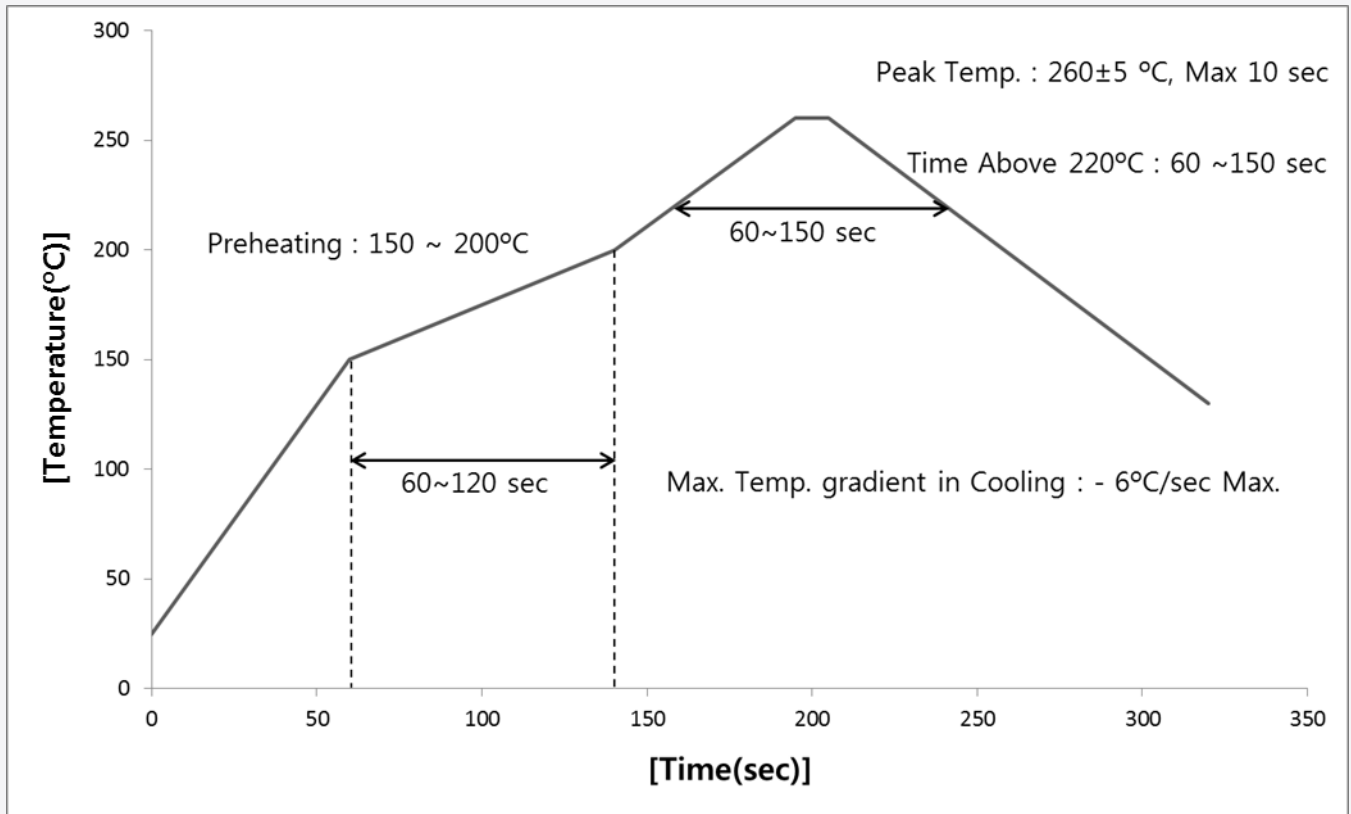
b) Criteria for Judging the Damage

Item	Symbol	Test Condition ($T_s = 25^\circ\text{C}$)	Limit	
			Min	Max
Forward Voltage	V_F	$I_F = 65$ mA	Init. Value * 0.9	Init. Value * 1.1
Luminous Flux	Φ_v	$I_F = 65$ mA	Init. Value * 0.7	Init. Value * 1.1

6. Soldering Conditions

a) Reflow Conditions (Pb free)

Reflow frequency: 2 times max.



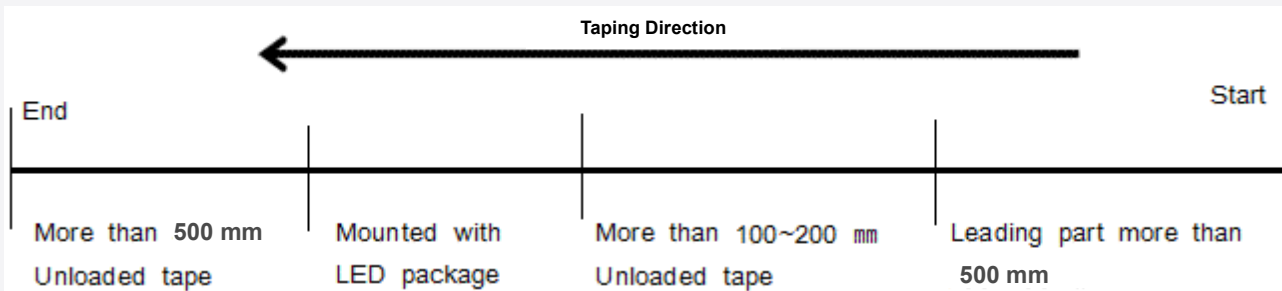
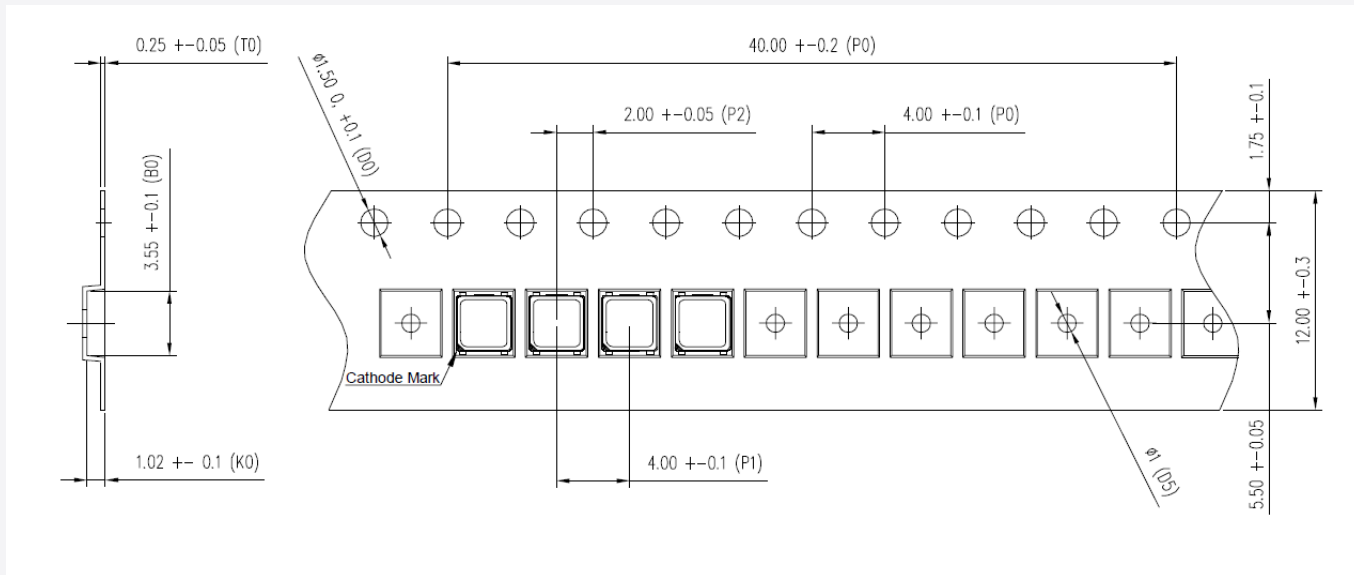
b) Manual Soldering Conditions

Not more than 5 seconds @ max. 300°C, under soldering iron.

7. Tape & Reel

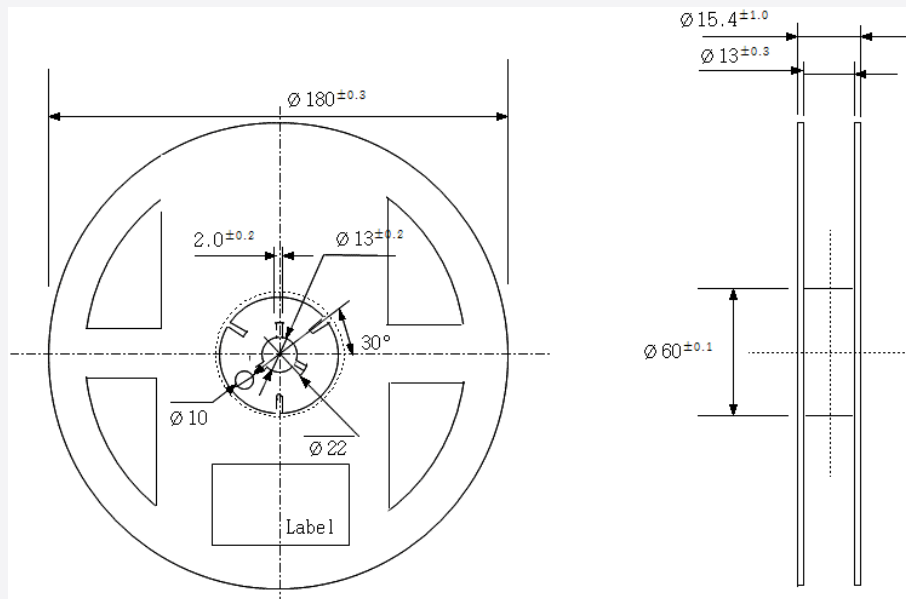
a) Taping Dimension

(unit: mm)



b) Reel Dimension

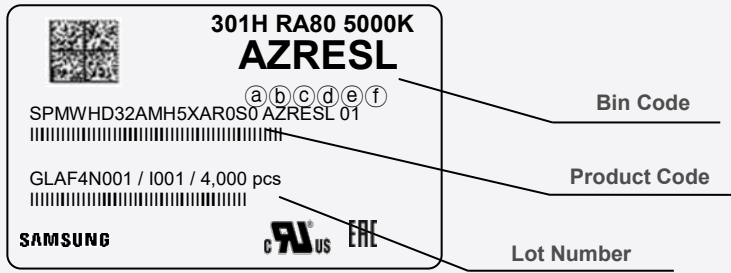
(unit: mm)

**Notes:**

- 1) Quantity: The quantity/reel is 4,000 pcs
- 2) Cumulative Tolerance: Cumulative tolerance / 10 pitches is ± 0.2 mm
- 3) Adhesion Strength of Cover Tape: Adhesion strength is 0.1-0.7 N when the cover tape is turned off from the carrier tape at 10° angle to the carrier tape
- 4) Packaging: P/N, Manufacturing data code no. and quantity are indicated on the aluminum packing bag

8. Label Structure

a) Label Structure



Note: Denoted bin code and product code above is only an example (see description on page 5)

Bin Code:

- ⒶⒷ: Forward Voltage bin (refer to page 9)
- ⒸⒹ: Chromaticity bin (refer to page 9-11)
- ⒺⒻ: Luminous Flux bin (refer to page 7)

b) Lot Number

The lot number is composed of the following characters:



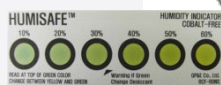
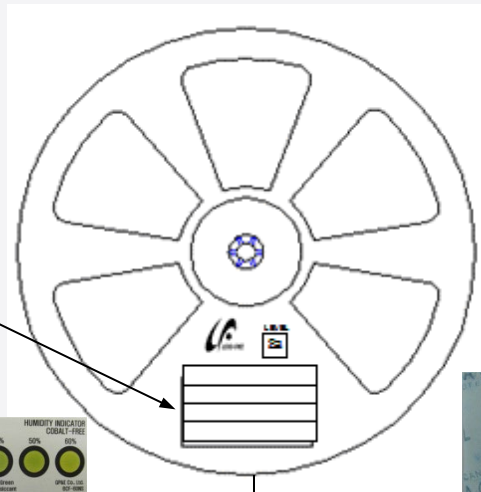
①②③④⑤⑥⑦⑧⑨ / 1ⒶⒷⒸ / 4,000 pcs

- ①② : Production site (GL: Tianjin, China, G4: Guangzhou, China, EH : Hanoi, Vietnam)
※ Sample product (SL: Kiheung, Korea)
- ③ : Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample)
- ④ : Year (D : 2019, E : 2020, F : 2021...)
- ⑤ : Month (1~9, A, B, C)
- ⑥ : Day (1~9, A, B~V)
- ⑦⑧⑨ : Serial number (001 ~ 999)
- ⒶⒷⒸ : Reel number (001 ~ 999)

9. Packing Structure

a) Packing Process (The quantity of PKG on the Reel to be Max 4,000pcs)

Reel



Aluminum Vinyl Packing Bag

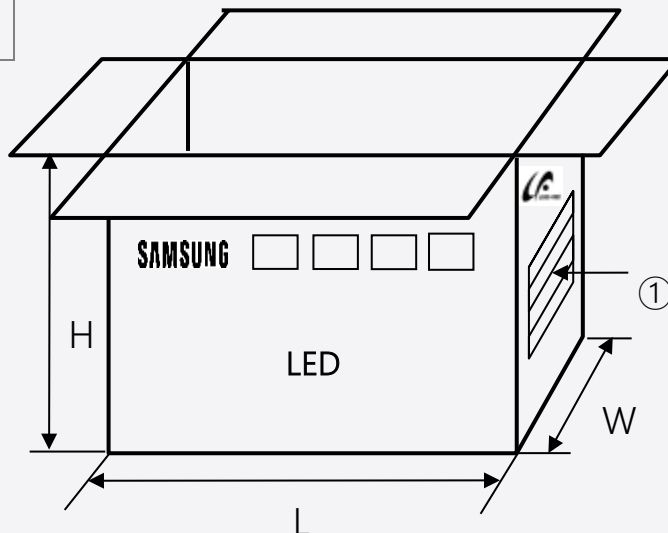


Outer Box

Material: Paper (SW3B(B))

Type	Size (mm)			Note
	L	W	H	
7 inch L	245 ± 5	220 ± 5	182 ± 5	Up to 10 reels
7 inch S	245 ± 5	220 ± 5	86 ± 5	Up to 5 reels

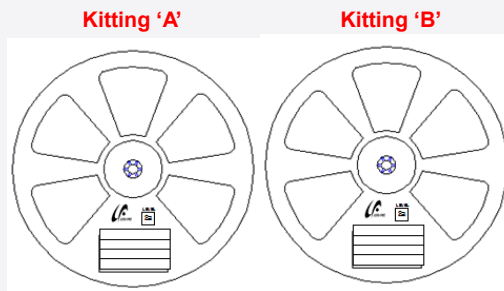
① Side Label



b) Packing Process for kitting (The quantity of PKG on the Reel to be Max 4,000pcs)

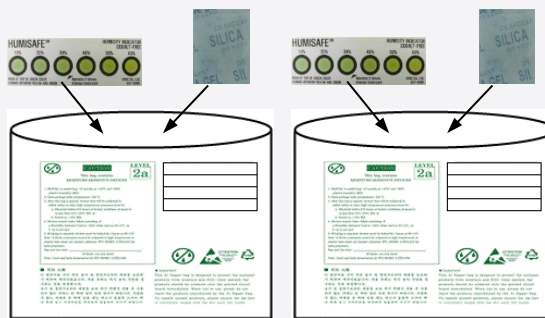
Reel

<p>Kitting 'A'</p>  <p>301H RA80 5000K AYR★SL SPMWH32AMH5XAR0L2 AYRESL 00 GLAE24003 / I001 / 4,000 pcs</p> <p>SAMSUNG   </p>	<p>Kitting 'B'</p>  <p>301H RA80 5000K AYR★SM SPMWH32AMH5XAR0L2 AYRFSL 00 GLAE24004 / I001 / 4,000 pcs</p> <p>SAMSUNG   </p>
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Aluminum Vinyl Packing Bag

<p>Kitting 'A'</p>  <p>301H RA80 5000K AYR★SL SPMWH32AMH5XAR0L2 AYRESL 00 GLAE24003 / I001 / 4,000 pcs</p> <p>SAMSUNG   </p>	<p>Kitting 'B'</p>  <p>301H RA80 5000K AYR★SM SPMWH32AMH5XAR0L2 AYRFSL 00 GLAW94002 / I001 / 4,000 pcs</p> <p>SAMSUNG   </p>
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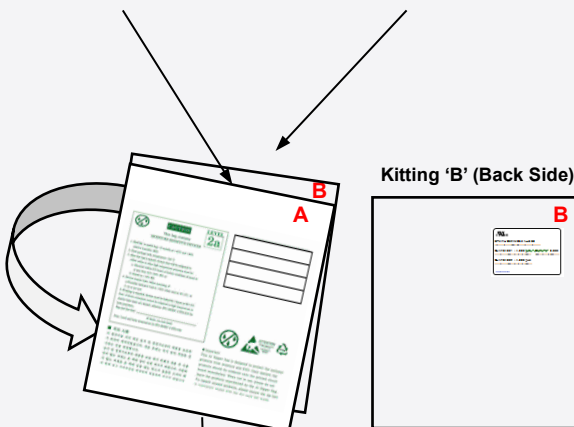


Kitting 'B' (back Side)

 <p>301H RA80 5000K SPMWH32AMH5XAR0L2 GLAE24003 / 4,000 pcs QUANTITY : 8,000 GLAE24004 / 4,000 pcs</p> <p>SAMSUNG   </p>
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Outer Box

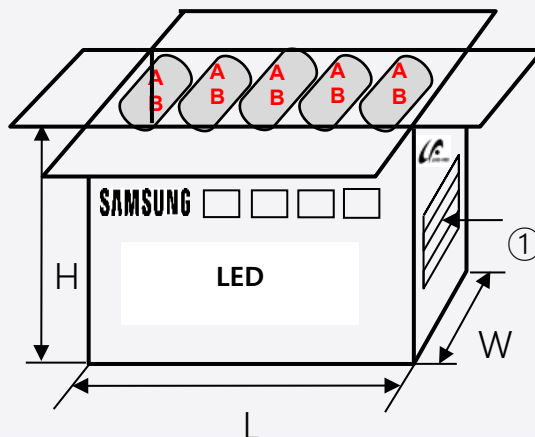
<p>Kitting 'A'</p>  <p>301H RA80 5000K AYR★SL SPMWH32AMH5XAR0L2 AYRESL 00 GLAE24003 / I001 / 20,000 pcs</p> <p>SAMSUNG [BOX Label]   </p>	<p>Kitting 'B'</p>  <p>301H RA80 5000K AYR★SM SPMWH32AMH5XAR0L2 AYRFSL 00 GLAE24004 / I001 / 20,000 pcs</p> <p>SAMSUNG [BOX Label]   </p>
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Note: "★" can be "E", "F", "G", "H", "J", "K", "L", "M" of the chromaticity bin.

Material: Paper (SW3B(B))

Type	Size (mm)			Note
	L	W	H	
7 inch L	245 ± 5	220 ± 5	182 ± 5	Up to 10 reels



10. Precautions in Handling & Use

- 1) For over-current protection, users are recommended to apply resistors connected in series with the LEDs to mitigate sudden change of the forward current caused by shift of forward voltage.
- 2) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the device.
- 3) When the device is in operation, the forward current should be carefully determined considering the maximum ambient temperature and corresponding junction temperature.
- 4) LEDs must be stored in a clean environment. Shelf life of sealed bags is 12 months at temperature 0~40 °C, 0~90 % RH.
- 5) After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
 - a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 °C / 60 % RH*^{Note 1}, or
 - b. Mounted within 24 hours (1 day) at an assembly line with a condition of more than 30 °C / 70 % RH*^{Note 2}, or
 - c. Stored at <10 % RH.

*Note 1, 2: IPC/JEDEC J-STD-033A, Recommended Equivalent Total Floor Life Table

Package Type and Body Thickness	Moisture Sensitivity Level	Maximum Percent Relative Humidity						Temperature
		40%	50%	60%	70%	80%	90%	
Body Thickness <2.1mm	Level 2a	∞	∞	28	1	1	1	30°C
		∞	∞	∞	2	1	1	25°C
		∞	∞	∞	2	2	1	20°C

- 6) Repack unused devices with anti-moisture packing, fold to close any opening and then store in a dry place.
- 7) Devices require baking before mounting, if humidity card reading is >60 % at 23 ± 5 °C.
- 8) Devices must be baked for 10~24 hours at 60 ± 5 °C, if baking is required.
- 9) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.
- 11) Risk of sulfurization (or tarnishing)
 The LED from Samsung uses a silver-plated lead frame and its surface color may change to black (or dark colored) when it is exposed to sulfur (S), chlorine (Cl) or other halogen compound. Sulfurization of lead frame may cause intensity degradation, change of chromaticity coordinates and, in extreme cases, open circuit. It requires caution. Due to possible sulfurization of lead frame, LED should not be used and stored together with oxidizing substances made of materials such as rubber, plain paper, lead solder cream, etc.

Legal and additional information.

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The company is redefining the worlds of TVs, smartphones, wearable devices, tablets, digital appliances, network systems, and memory, system LSI, foundry and LED solutions. For the latest news, please visit the Samsung Newsroom at news.samsung.com.

"Samsung provides limited warranty for its LED products, the full text of which is available at <https://www.samsung.com/led/support/warranties>"

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Samsung Electronics Co., Ltd.

95, Samsung 2-ro

Giheung-gu

Yongin-si, Gyeonggi-do, 446-711

KOREA

www.samsungled.com

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